

# HMP60N380E7

## N-Channel eMOS E7 Power MOSFET

600 V, 9.6 A, 380 mΩ

### Description

The 600V eMOS E7 is an advanced Power Master Semiconductor's Super Junction MOSFET family by utilizing charge balance technology for excellent low on-resistance and gate charge.

This technology combines the benefits of a fast switching performance with ease of usage and robustness.

Consequently, the eMOS E7 family is suitable for application requiring high power density and superior efficiency.

### Features

$BV_{DSS}$ @ $T_{J,max}$	$I_D$	$R_{DS(on),max}$	$Q_{g,typ}$
650 V	9.6 A	380 mΩ	15.5 nC

- Reduced Switching & Conduction Losses
- Lower Gate Resistance
- 100% Avalanche Tested
- Pb-free, Halogen Free, and RoHS Compliant

### Applications

- PFC, Hard & Soft Switching Topologies
- Industrial & Consumer Power Supplies



### Absolute Maximum Ratings ( $T_C = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter		Value	Unit
$V_{DSS}$	Drain to Source Voltage		600	V
$V_{GSS}$	Gate to Source Voltage		$\pm 30$	V
$I_D$	Drain Current	Continuous ( $T_C = 25^\circ\text{C}$ )	9.6	A
		Continuous ( $T_C = 100^\circ\text{C}$ )	6.1	
$I_{DM}$	Drain Current	Pulsed (Note1)	28.8	A
$E_{AS}$	Single Pulsed Avalanche Energy		40	mJ
$I_{AS}$	Avalanche Current		2.5	A
$E_{AR}$	Repetitive Avalanche Energy		0.87	mJ
$dv/dt$	MOSFET $dv/dt$		100	V/ns
	Peak Diode Recovery $dv/dt$		20	
$P_D$	Power Dissipation	( $T_C = 25^\circ\text{C}$ )	87	W
		Derate Above 25°C	0.7	W/ $^\circ\text{C}$
$T_J, T_{STG}$	Operating and Storage Temperature Range		-55 to 150	°C
$T_L$	Maximum Lead Temperature for Soldering, 1/8" from Case for 10 Seconds		260	°C

### Thermal Characteristics

Symbol	Parameter	Value	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	1.43	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	

**Package Marking and Ordering Information**

Part Number	Top Marking	Package	Packing Method	Quantity
HMP60N380E7	HMP60N380E7	TO-220	Tube	50 units

**Electrical Characteristics** ( $T_C = 25^\circ\text{C}$  unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
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**Off Characteristics**

$\text{BV}_{\text{DSS}}$	Drain to Source Breakdown Voltage	$V_{\text{GS}} = 0 \text{ V}, I_D = 1 \text{ mA}$	600			V
		$V_{\text{GS}} = 0 \text{ V}, I_D = 1 \text{ mA}, T_J = 150^\circ\text{C}$	650			
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{\text{DS}} = 600 \text{ V}, V_{\text{GS}} = 0 \text{ V}$			1	$\mu\text{A}$
		$V_{\text{DS}} = 480 \text{ V}, V_{\text{GS}} = 0 \text{ V}, T_J = 125^\circ\text{C}$		2		
$I_{\text{GSS}}$	Gate-Source Leakage Current	$V_{\text{GS}} = \pm 30 \text{ V}, V_{\text{DS}} = 0 \text{ V}$			$\pm 100$	nA

**On Characteristics**

$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{GS}} = V_{\text{DS}}, I_D = 0.8 \text{ mA}$	2.5		4.5	V
$R_{\text{DS(on)}}$	Static Drain to Source On Resistance	$V_{\text{GS}} = 10 \text{ V}, I_D = 4.0 \text{ A}$		318	380	$\text{m}\Omega$

**Dynamic Characteristics**

$C_{\text{iss}}$	Input Capacitance	$V_{\text{DS}} = 400 \text{ V}, V_{\text{GS}} = 0 \text{ V}, f = 250 \text{ kHz}$		628		pF
$C_{\text{oss}}$	Output Capacitance		20			pF
$C_{\text{o(tr)}}$	Time Related Output Capacitance	$V_{\text{DS}} = 0 \text{ V to } 400 \text{ V}, V_{\text{GS}} = 0 \text{ V}$		239		pF
$C_{\text{o(er)}}$	Energy Related Output Capacitance		30			pF
$Q_{\text{g(tot)}}$	Total Gate Charge at 10 V	$V_{\text{DS}} = 400 \text{ V}, I_D = 4.0 \text{ A}, V_{\text{GS}} = 10 \text{ V}$		15.5		nC
$Q_{\text{gs}}$	Gate to Source Charge			3.0		nC
$Q_{\text{gd}}$	Gate to Drain "Miller" Charge			7.9		nC
$R_G$	Gate Resistance	$f = 1 \text{ MHz}$		1.0		$\Omega$

**Switching Characteristics**

$t_{\text{d(on)}}$	Turn-On Delay Time	$V_{\text{DS}} = 400 \text{ V}, I_D = 4.0 \text{ A}, V_{\text{GS}} = 10 \text{ V}, R_G = 10 \Omega$ See Figure 13		8		ns
$t_r$	Turn-On Rise Time			13		ns
$t_{\text{d(off)}}$	Turn-Off Delay Time			30		ns
$t_f$	Turn-Off Fall Time			8		ns

**Source-Drain Diode Characteristics**

$I_S$	Maximum Continuous Diode Forward Current			9.6	A	
$I_{\text{SM}}$	Maximum Pulsed Diode Forward Current			28.8	A	
$V_{\text{SD}}$	Diode Forward Voltage	$V_{\text{GS}} = 0 \text{ V}, I_{\text{SD}} = 4.0 \text{ A}$		1.2	V	
$t_{\text{rr}}$	Reverse Recovery Time	$V_{\text{DD}} = 400 \text{ V}, I_{\text{SD}} = 4.0 \text{ A}, dI_F/dt = 100 \text{ A}/\mu\text{s}$		221		ns
$Q_{\text{rr}}$	Reverse Recovery Charge			1.8		$\mu\text{C}$

※Notes:

- Repetitive rating: pulse-width limited by maximum junction temperature.
- $I_{\text{AS}} = 2.5 \text{ A}$ ,  $R_G = 25 \Omega$ , starting  $T_J = 25^\circ\text{C}$ .
- $I_{\text{SD}} \leq 4 \text{ A}$ ,  $di/dt \leq 100 \text{ A}/\mu\text{s}$ ,  $V_{\text{DD}} \leq 400 \text{ V}$ , starting  $T_J = 25^\circ\text{C}$ .

## Typical Performance Characteristics

Figure 1. On-Region Characteristics

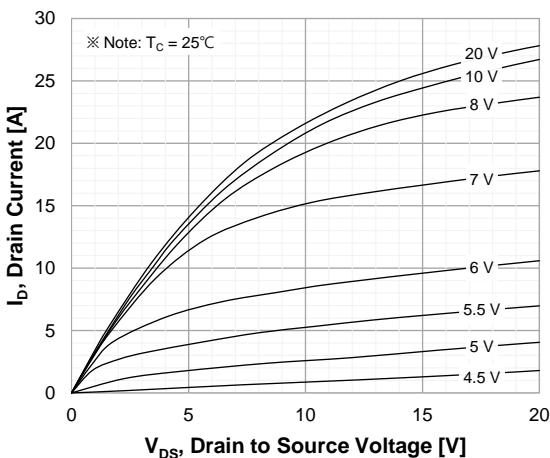


Figure 2. Transfer Characteristics

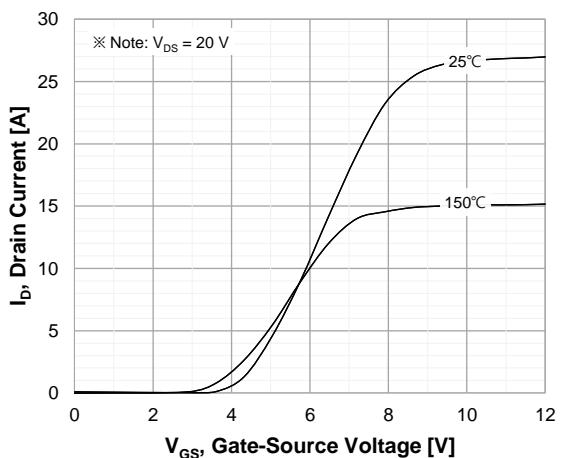


Figure 3. On-Resistance Characteristics vs. Drain Current and Gate Voltage

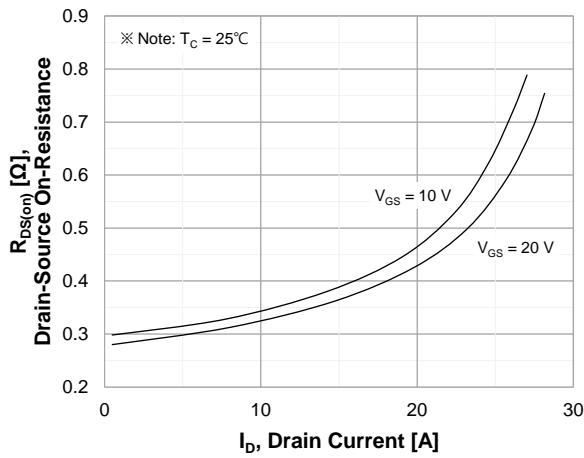


Figure 4. Diode Forward Voltage Characteristics vs. Source-Drain Current and Temperature

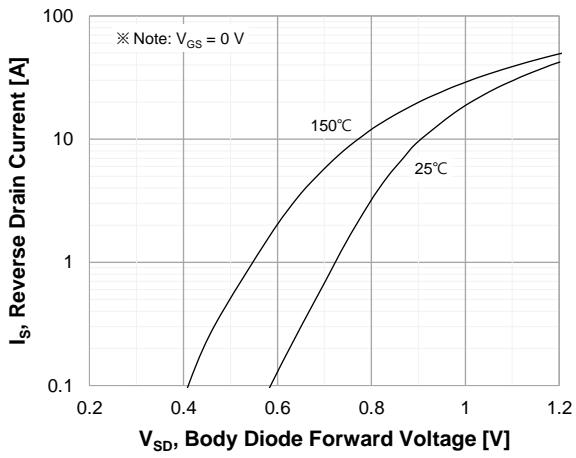


Figure 5. Capacitance Characteristics

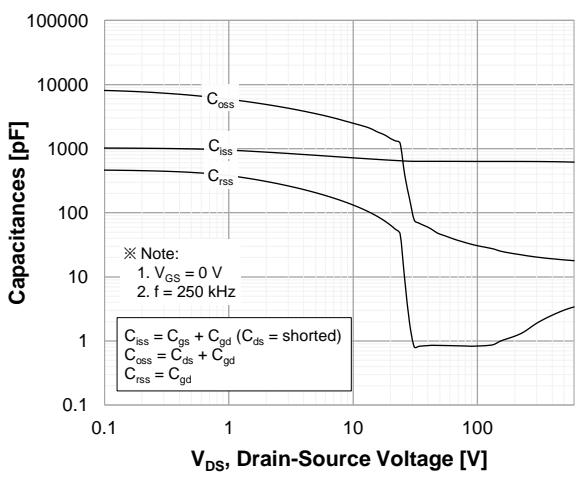
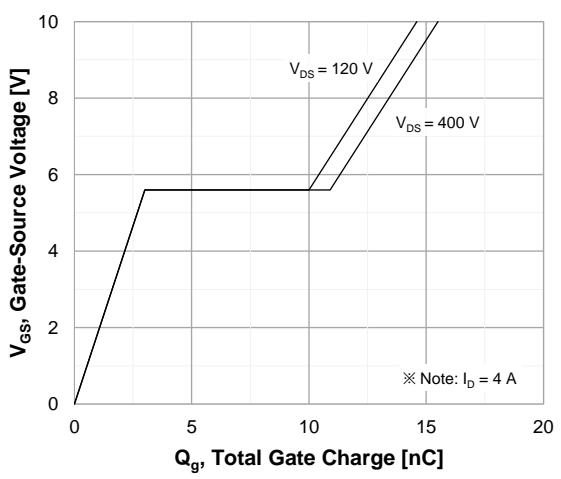
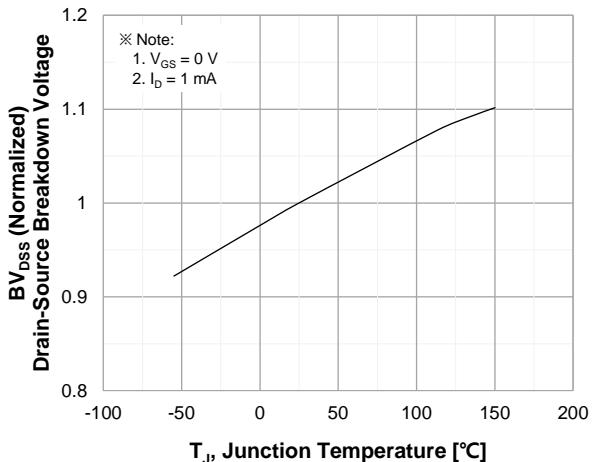


Figure 6. Gate Charge Characteristics

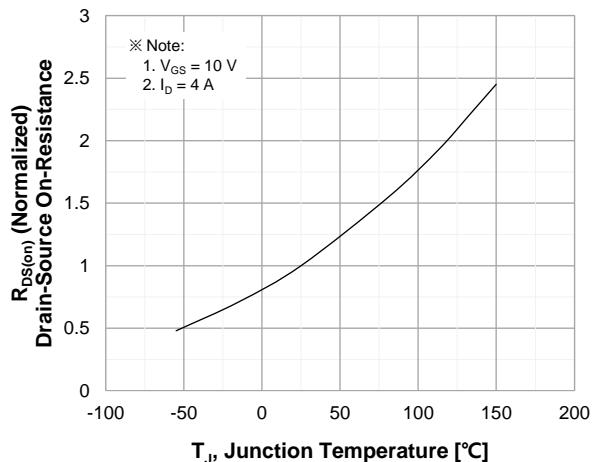


### Typical Performance Characteristics

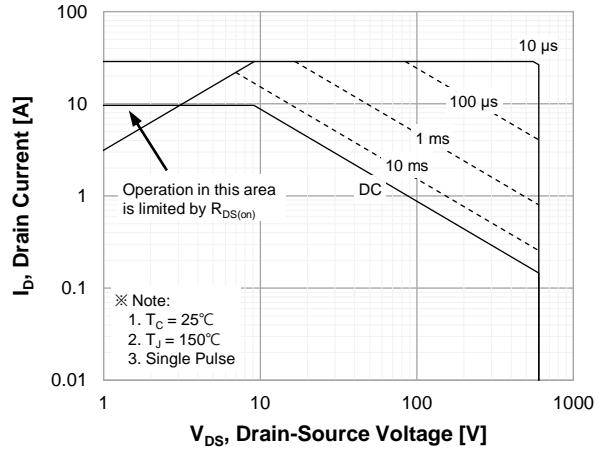
**Figure 7. Breakdown Voltage Characteristics vs. Temperature**



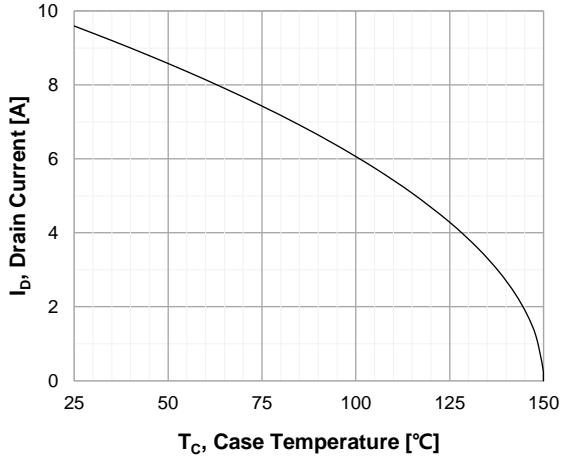
**Figure 8. On-Resistance Characteristics vs. Temperature**



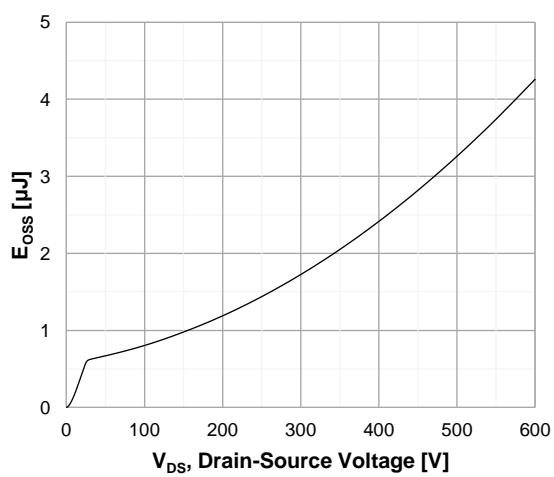
**Figure 9. Maximum Safe Operating Area**



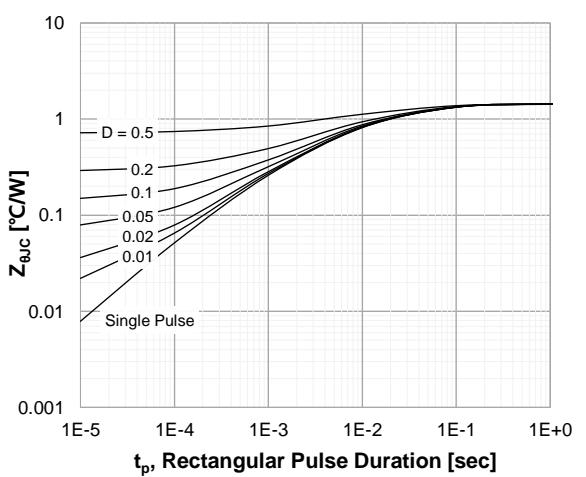
**Figure 10. Maximum Drain Current vs. Case Temperature**



**Figure 11.  $E_{oss}$  vs. Drain to Source Voltage**

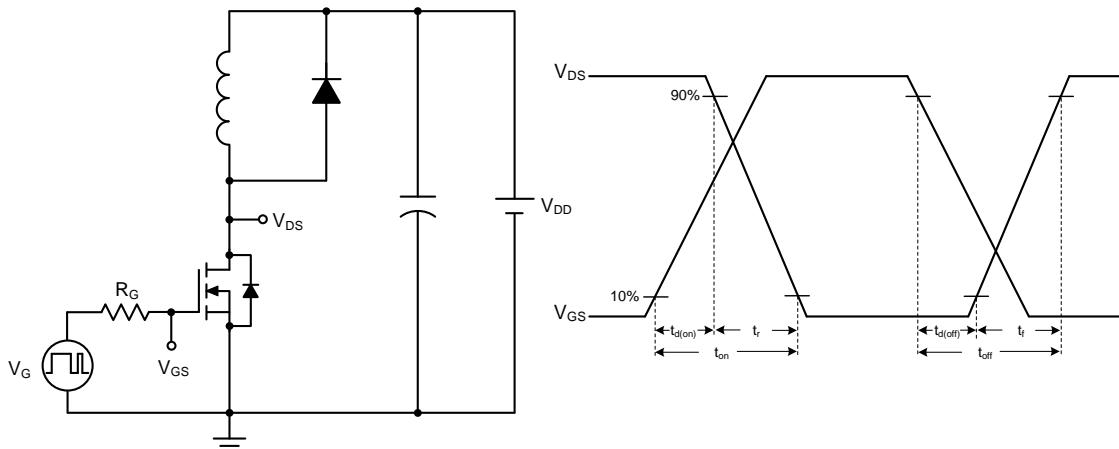


**Figure 12. Transient Thermal Response Curve**

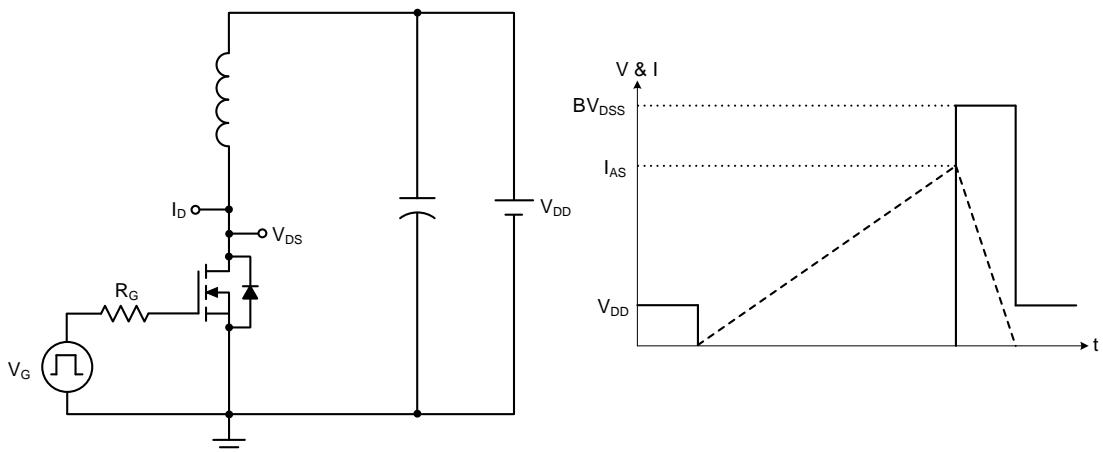


### Test Circuits

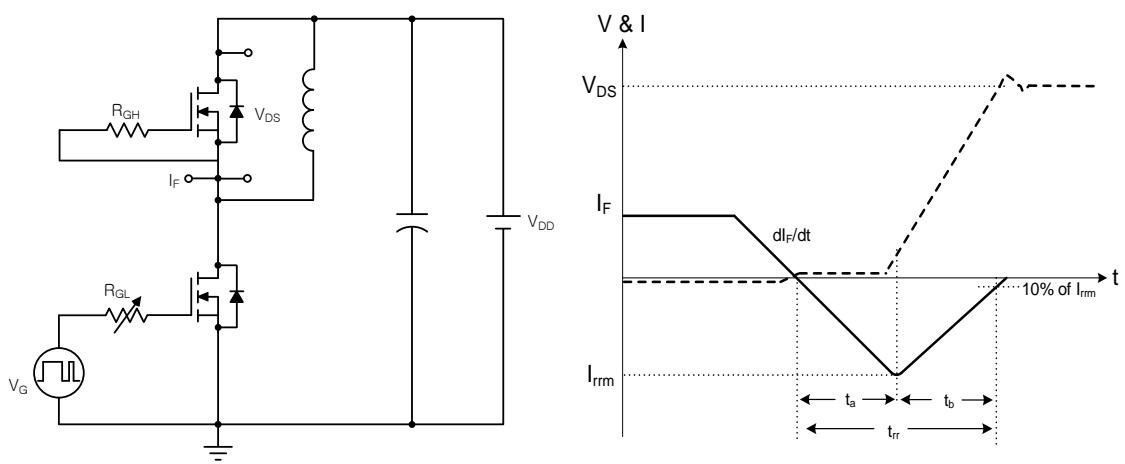
**Figure 13. Inductive Load Switching Test Circuit and Waveforms**



**Figure 14. Unclamped Inductive Switching Test Circuit and Waveforms**

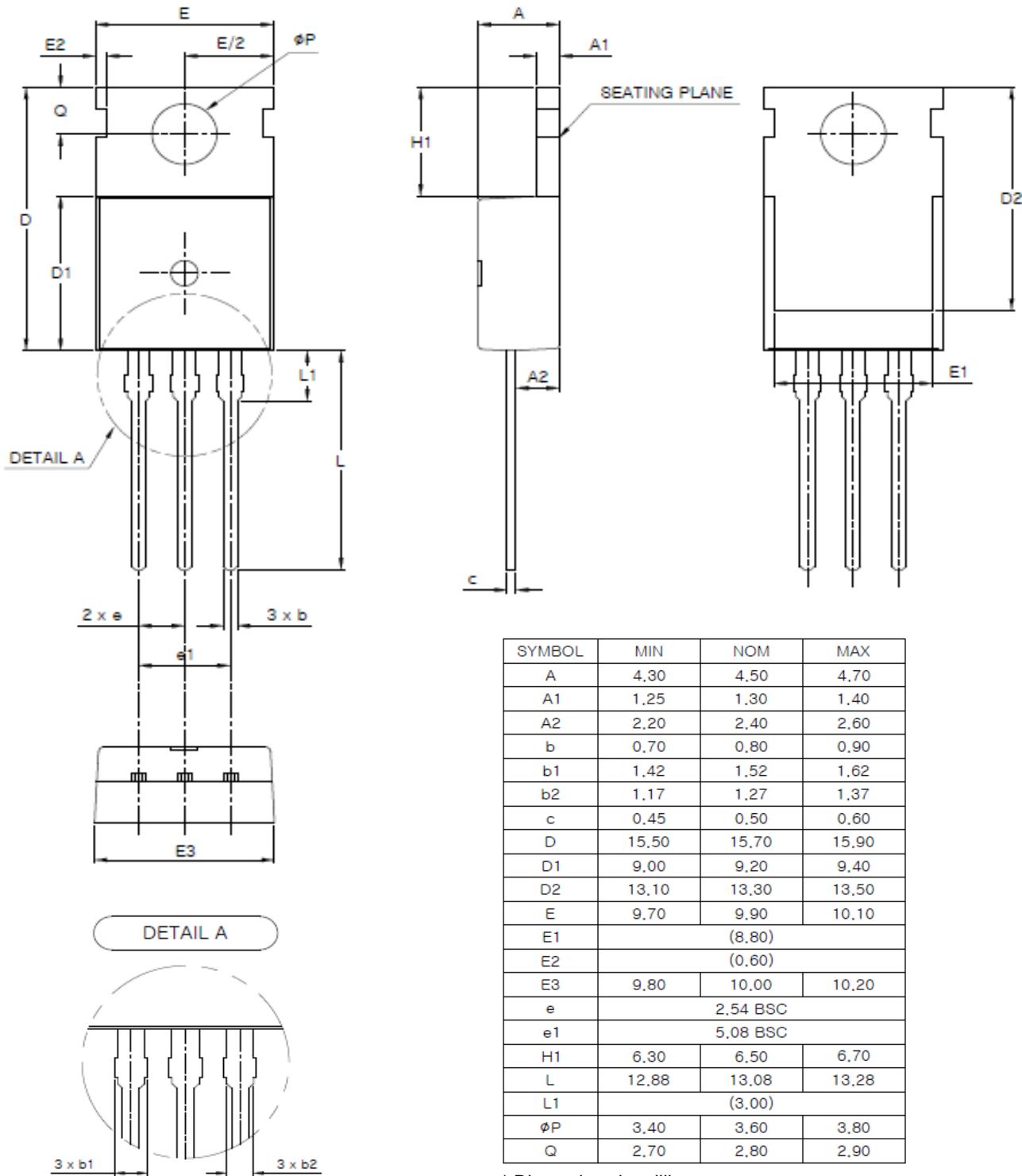


**Figure 15. Peak Diode Recovery  $dv/dt$  Test Circuit and Waveforms**



## Package Outlines

## TO-220



SYMBOL	MIN	NOM	MAX
A	4.30	4.50	4.70
A1	1.25	1.30	1.40
A2	2.20	2.40	2.60
b	0.70	0.80	0.90
b1	1.42	1.52	1.62
b2	1.17	1.27	1.37
c	0.45	0.50	0.60
D	15,50	15,70	15,90
D1	9,00	9,20	9,40
D2	13,10	13,30	13,50
E	9,70	9,90	10,10
E1	(8,80)		
E2	(0,60)		
E3	9,80	10,00	10,20
e	2,54 BSC		
e1	5,08 BSC		
H1	6,30	6,50	6,70
L	12,88	13,08	13,28
L1	(3,00)		
φP	3,40	3,60	3,80
Q	2,70	2,80	2,90

\* Dimensions in millimeters